

OPTO-ISOLATED PHOTOVOLTAIC ISO-GATETM MOSFET DRIVERS

DIG-11-06-030

DIG-11-06-150 DIG-11-08-050 DIG-12-06-025

Features:

- Completely Isolated Voltage Signal Generation
- Dielectrically Isolated
- Logic Circuit Compatibility
- High Open Circuit Voltage
- High Operating Temperature
- ➢ Fast Response Time
- High Isolation Resistance
- Excellent Input/Output Linearity
- Self Limiting Gate Voltage

DIG-12-08-010 DIG-12-08-045 DIG-12-06-100 DIG-12-06-250

Applications:

- Gate Drive For MOS devices
- Gate Drive For SCR
- Solid-State Relays
- Interface Between Logic Circuits & External Loads
- ➢ A.T.E. (Automatic Test Equipment)
- Switching Equipment
- Isolation Amplifiers
- Load Control From Microprocessor I/O Ports
- Thermocouple Open Detectors

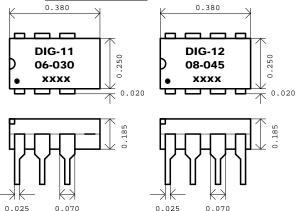
Description:

The photovoltaic MOSFET driver is a State-of- the-Art, optically coupled floating power source used primarily to control MOSFETs when electrical isolation between input and output is required. The ISO-GATETM is a state-of-the-art optoisolator incorporating DIONICS' photovoltaic (PV) diode arrays and an infrared LED. The diode array is a unique I.C. consisting of series-connected photovoltaic diodes. The diodes are completely isolated from each other and from their common substrate by means of SiO₂ Dielectric Isolation (DI). These photovoltaic output chips are electrically isolated but optically coupled to the LED.

The typical input circuit to the LED is a limiting resistor connected in series with the LED. When activated, the LED emits infrared light towards the photovoltaic diode array, which then responds by generating an open circuit voltage (Voc). This Voc is floating and is therefore completely isolated. The Voc value depends on the LED input drive and load impedance. DIONICS, Inc offers a wide variety of package styles including low-cost plastic Mini-DIP's, high reliability TO-5 metal cans, 8-pin ceramic side brazed DIP's and ceramic chip carriers for hybrid manufacturers. Other custom packages and custom designs are also available.

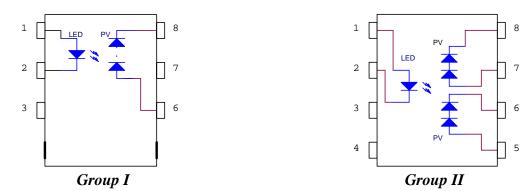
- o Group I: DIG-11-06-030; DIG-11-06-150; DIG-11-08-050.
- o Group II: DIG-12-06-025; DIG-12-06-100; DIG-12-06-250; DIG-12-08-010; DIG-12-08-045.

✤ <u>Package Layout:</u>



Pin Designation						
Pin Number	Group I	Group II				
1	Input +	Input +				
2	Input -	Input -				
3	Not Connected	Not Connected				
4	Not Connected	Not Connected				
5	Not Connected	Output1+				
6	Output +	Output1-				
7	Not Connected	Output2+				
8	Output -	Output2-				

Group I and Group II Equivalent Circuits:



Absolute Maximum Ratings (T _a = 25°C)									
LED Forward Current	Steady State	100 mA							
LED Forward Current	Peak 10% Duty Cycle	250 mA							
LED Forward Voltage	$I_f = 20mA$	1.7V*							
LED Reverse Current	$V_r = 3V$	100µA							
LED Reverse Voltage		5V							
Output Forward Voltage	$I_f = 10 \mu A$	20V							
Lead Soldering Time	At 260°C	10 sec							
Storage Temperature		-50 to 125 [°] C							
Power Dissipation		150 mW							

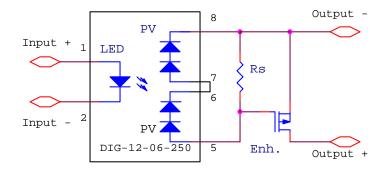
* Note: DIG-12-06-100 and DIG-12-06-250 are rated @ 3.4 V Max.

* Individual Channel Electrical Characteristics (Ta = 25°C)

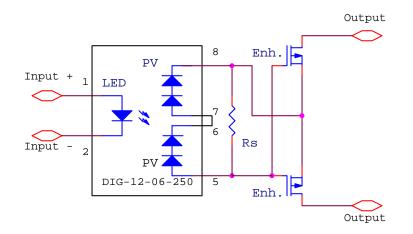
	MODEL NUMBERS DIG -																	
		12-0	8-010	12-06-025		12-08-045		12-06-100		12-06-250		11-06-030		11-08-050		11-06-150		Unit
Parameter	Symbol	Min.	Тур.	Min.	Тур.	Min.	Typ.	Min.	Тур.	Min.	Тур.	Min.	Тур.	Min.	Тур.	Min.	Тур.	
Open Circuit Voltage	Voc																	
$I_{led} = 2mA$			8.0		6.5		8.0		6.0		6.0		5.5		9.0		6.0	V
$I_{led} = 10 m A$		8.0	9.0	6.5	7.5	8.5	9.0	6.5	7.0	6.5	7.3	6.0	6.5	7.5	10.0	6.5	7.0	V
$I_{led} = 30 \text{mA}$		9.0	10.0	7.0	6.3	9.5	10.0	7.5	7.8	7.5	8.0	6.5	7.0	8.5	11.0	7.5	8.0	V
Short Circuit Current	I _{sc}																	
$I_{led} = 2mA$			0.5		1.0		1.0		2.0		3.0		1.1		2.0		3.0	μA
$I_{\text{led}} = 10 \text{mA}$		1.35	3.0	3.0	6.0	4.0	8.0	8.0	12.0	12.5	25.0	1.0	7.0	4.0	13.0	10.0	18.0	μA
$I_{led} = 30 \text{mA}$		4.0	9.0	9.0	20.0	12.0	25.0	30.0	40.0	37.5	75.0	3.5	20.0	12.0	40.0	30.0	55.0	μA
Turn-On Time																		
$I_f = 50 \text{ mA}; C = 10 \text{pF}$																		
P.W = 100us;	Ton	-	3.0	-	10.0	-	8.0	-	3.0	-	3.0	-	8.0	-	5.0	-	3.0	μs
f =1kHz; $R_s = 10M\Omega$																		
Temp. Coefficient	Θ	-	-100	-	-80	-	-100	-	-80	-	-80	-	-40	-	-50	-	-40	mV/ºC
(Channels in Series)																		
Isolation Voltage	V _{iso}																	
$I_{iso} = 50 \mu A @ 2 sec$			2500							2500 VDC								
Operating Temp.	Top		-50° C To $+100^{\circ}$ C									-50 ⁰ C To +80 ⁰ C						
(Channels in Series)																		
Turn-Off Time	Toff																	
$I_f = 50 \text{ mA}; C = 10 \text{pF}$			The P	hotovo	ltaic a	rray sto	ps gene	erating c	urrent	within	one m	icrosec	cond o	f the tr	ailing e	edge		
P.W = 100us;			of LED current the discharge time is solely dependent upon discharge circuitry and capacitive load.															
f =1kHz; $R_s = 10M\Omega$																		

Typical Applications

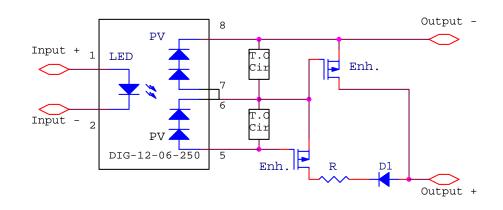
1. Power MOSFET Photovoltaic SPST N/O DC Relays



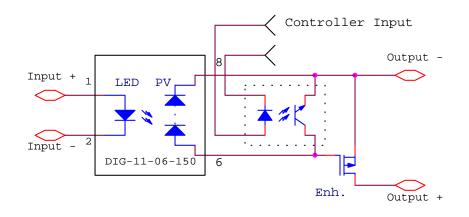
2. Power MOSFET SPDT Photovoltaic SPST N/O AC-DC Relays:



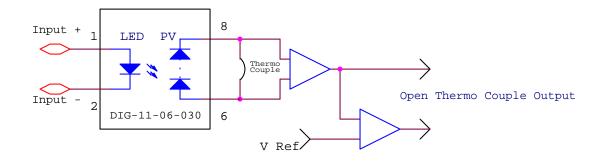
3. Power MOSFET Photovoltaic SPST N/O Relays With High Speed Turn-Off:



4. Power MOSFET Photovoltaic SPST N/O Relays With Opto-Transitor for High Speed Turn-Off:



5. <u>Open Thermocouple Detector:</u>



6. Isolation Amplifier:

